505159604 10/25/2018

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KAZUHIKO HIGAI	10/29/2014
YUJI YAMASAKI	10/31/2014

RECEIVING PARTY DATA

Name:	JFE STEEL CORPORATION	
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Internal Address:	CHIYODA-KU	
City:	TOKYO	
State/Country:	JAPAN	
Postal Code:	100-0011	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15999494

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ATTORNEY DOCKET NUMBER: JFE-14-2384DIV (000471) NAME OF SUBMITTER: LESLIE J. HOOD SIGNATURE: /LJH/ **DATE SIGNED:** 10/25/2018

Total Attachments: 1

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PATENT REEL: 047313 FRAME: 0079 505159604

ASSIGNMENT

WHEREAS, we, Kazuhiko Higai and Yuji Yamasaki, citizens of Japan, both residing at c/o Intellectual Property Department, JFE Steel Corporation, 2-3, Uchisaiwai-cho 2-chome, Chiyoda-ku, Tokyo 1000011 Japan, (hereinafter referred to as "the undersigned"), having made an invention entitled METHOD FOR MANUFACTURING CLOSED-STRUCTURE PART AND APPARATUS FOR THE SAME, identified in International Application No. PCT/JP2012/060640, and in US Application No. 14/394, 192 (DLA Piper is authorized to insert the Serial No. when known),

WHEREAS, JFE Steel Corporation, with offices located at 2-3, Uchsaiwai-cho 2-chome, Chiyoda-ku, Tokyo 1000011 Japan (hereinafter referred to as "the assignee"), is desirous of acquiring the entire right, title and interest in said invention, said US application and all letters patent issuing for said invention,

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and of other good and valuable consideration, receipt of which is hereby acknowledged, the undersigned, intending to be legally bound, do hereby sell, assign and transfer to the assignee the entire right, title and interest, for the United States of America, its territories and possessions, and for all foreign countries, in said invention, including said US application, all divisions and continuations thereof, all rights to claim priority based thereon, all rights to file foreign applications on said invention, and all letters patent and reissues thereof, issuing for said invention in the United States of America and in any and all foreign countries.

It is agreed that the undersigned shall be legally bound, upon request of the assignee, or its successors or assigns or a legal representative thereof, to supply all information and evidence of which the undersigned has knowledge or possession, relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention in the United States of America and foreign countries in the name of the assignee, and to execute all instruments proper to carry out the intent of this instrument. If the undersigned includes more than one individual, these obligations shall apply to all of the undersigned both individually and collectively.

The rights and property herein conveyed by the undersigned are free and clear of any encumbrance.

EXECUTED on the date(s) set forth below.

October 29, 2014

October 31, 2014

Date

Kazuhiko Higai

Kazuhiko Higai

Yuji Manasaki

Yulii Wamasaki

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PATENT REEL: 047313 FRAME: 0080

RECORDED: 10/25/2018